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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant: Robert F. Payne, et al.

Docket Number: TI-37350

Serial No.: **10/765,377**

Art Unit: 2816

Filed: 01/27/04

Examiner: Tuan Thieu Lam

For: High Performance Sense Amplifiers

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NAME OF INVENTOR(S): Robert F. Payne, et al.	
TITLE OF INVENTION: High Performance Sense Amplifiers	
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